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	Form PTO-1595 R 10262	U.S. Patent and Trademark Office	
	OMB No. 0651-0027 (exp. 5/31/2002) PATENTS	SONLY	
	To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof		
	Name of conveying party(ies):	Name and address of receiving party(ies)	
	Naoshi Kobuya (10/15/2003), Toru Masano (10/16/2003), Motoya Itako (10/15/2003), Hiroshi	Name: Sony Corporation	
	(10/16/2003), Motoya Itako (10/15/2003), Hilostii Nagasawa (10/16/2003), and Atsushi Noda	Internal Address:	
	(10/16/2003)	Street Address:	
	Additional name(s) of conveying party(les) Yes X No	Street Address: 7-35, Kitashinagawa 6-chome Shinagawa-Ku	
	3. Nature of Conveyance:		
	X Assignment Merger		
	Security Agreement Change of Name	City: Tokyo	
	Other	Country: Japan Zip: 141-0001	
	Execution Date: see Box 1, conveying parties	Additional name(s) & Yes X No address(es) attached:	
	4. Application number(s) or patent number(s):		
	If this document is being filed together with a new application, the extension A. Patent Application No.(s): 10/634,374	ecution date of the new application is: B. Patent No.(s):	
	Additional numbers attached? Yes x No		
	Name and address of party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved: 1 1	
	Name: Robert B. Cohen LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 3.41) \$40.00	
		Enclosed	
	Street Address: 600 South Avenue West	x Authorized to be charged to deposit account	
/12/2003 38 YRH	E 00000114 121095 10634374	Authorized to be charged to credit card (Form 2038 enclosed)	
FC:8021	40.00 BB	8. Deposit account number:	
	City: State: Zip:	12-1095	
	Westfield NJ 07090	(Attach duplicate copy of this page if paying by deposit account)	
	DO NOT USE	THIS SPACE	
	9. Statement and signature.		
	To the best of my knowledge and belief, the foregoing info is a true copy of the original document.	rmation is true and correct and any attached copy	
	Robert B. Cohen	December 4, 2003	
	Name of Person Signing	Signature Date	
	Total number of pages including cover sheet, attach	nments, and documents: 3	
	465855 1.DOC		

Docket Number: SONYJP 3.0-318 Sony Ref. No.: S03P0950US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

ELECTRONIC GUIDE SYSTEM, CONTENTS SERVER FOR ELECTRONIC GUIDE SYSTEM, PORTABLE ELECTRONIC GUIDE DEVICE, AND INFORMATION PROCESSING METHOD FOR ELECTRONIC GUIDE SYSTEM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 10/634,374, Filing Date: August 5, 2003.

This assignment executed on the dates indicated below.

Naoshi Kobuya	
Name of First or Sole Inventor	Execution Date of U.S. Patent Application
Гокуо, Japan	
Residence of First or Sole Inventor	
Naoshi Kobuya	Octo-ber 15, 2003
Signature of First or Sole Inventor	Date of this Assignment

PATENT REEL: 014774 FRAME: 0102

Docket Number: SONYJP 3.0-318

Toru Masano	
Name of Second Joint Inventor	Execution Date of U.S. Patent Application
Kagawa, Japan	
Residence of Second Joint Inventor	
Toru Masano	October 16,2003
Signature of Second Joint Inventor	Date of this Assignment
Motoya Itako	
Name of Third Joint Inventor	Execution Date of U.S. Patent Application
Tokyo, Japan	
Residence of Third Joint Inventor	
Motoya Xtako	October 15. 2003
Signature of Third Joint Inventor	Date of this Assignment
Hiroshi Nagasawa	
Name of Fourth Joint Inventor	Execution Date of U.S. Patent Application
Tokyo, Japan	
Residence of Fourth Joint Inventor	
Hiroshi Naga some	October 16,2003
Signature of Fourth Joint Inventor	Date of this Assignment
Atsushi Noda	
Name of Fifth Joint Inventor	Execution Date of U.S. Patent Application
Tokyo, Japan	
Residence of Fifth Joint Inventor	
Atsushi Noda	October 16, 2003.
Signature of Fifth Joint Inventor	Date of this Assignment

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RECORDED: 12/08/2003

PATENT REEL: 014774 FRAME: 0103